ΡΛΝ	ĴΪΤ
	SEMI CONDUCTOR

## 60V N-Channel Enhancement Mode MOSFET

Current

250mA

#### Features

Voltage

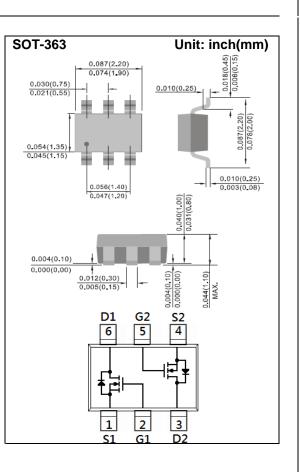
• RDS(ON) , VGS@10V, ID@600mA<3Ω

60 V

- RDS(ON) , VGS@4.5V, ID@200mA<4Ω
- Advanced Trench Process Technology
- Specially Designed for Relay driver, Speed line drive, etc.
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

### **Mechanical Data**

- Case: SOT-363 Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0002 ounces, 0.006 grams
- Marking: T2B



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V <sub>DS</sub>	60	V
Gate-Source Voltage		V <sub>GS</sub>	<u>+</u> 30	V
Continuous Drain Current		I <sub>D</sub>	250	mA
Pulsed Drain Current		I <sub>DM</sub>	1000	mA
Power Dissipation	T <sub>A</sub> =25°C	P <sub>D</sub>	350	mW
	Derate above 25°C		4	mW/°C
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~150	°C
Typical Thermal resistance - Junction to Ambient <sup>(Note 3)</sup>		$R_{ extsf{ heta}JA}$	357	°C/W



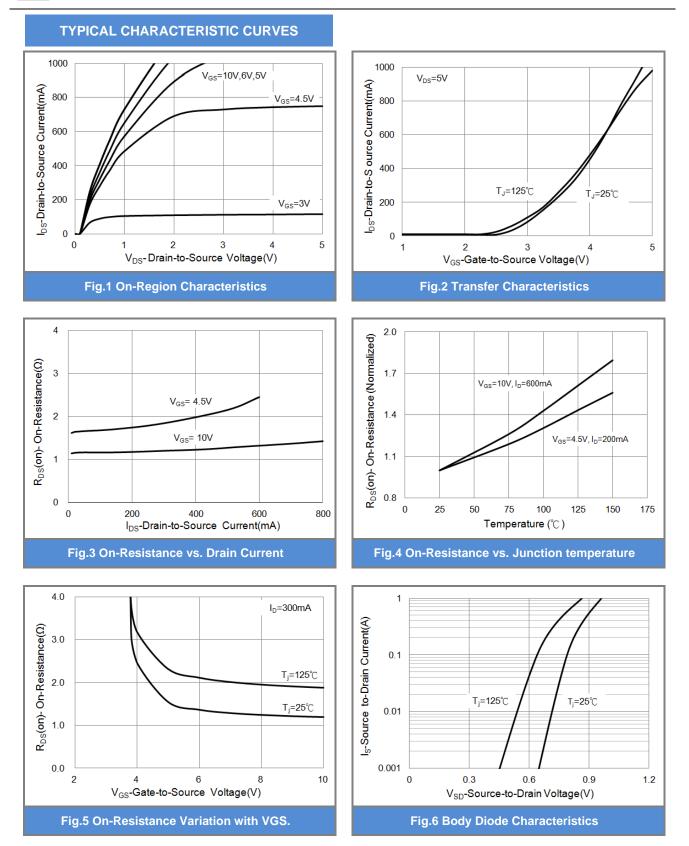
## **Electrical Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

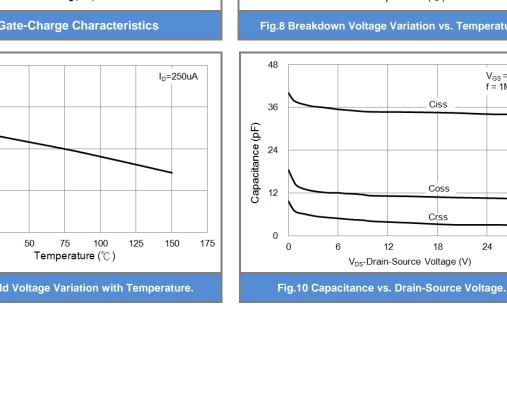
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	$BV_{DSS}$	V <sub>GS</sub> =0V,I <sub>D</sub> =250uA	60	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	1.0	1.8	2.5	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS}$ =10V,I <sub>D</sub> =600mA	-	1.3	3	Ω
		V <sub>GS</sub> =4.5V,I <sub>D</sub> =200mA	-	1.7	4	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 30V,V <sub>DS</sub> =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 4)		-		_	_	_
Total Gate Charge	Qg	V <sub>DS</sub> =15V, I <sub>D</sub> =600mA, V <sub>GS</sub> =4.5V	-	0.82	-	nC
Gate-Source Charge	$Q_gs$		-	0.53	-	
Gate-Drain Charge	$Q_gd$		-	0.22	-	
Input Capacitance	Ciss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHZ	-	34	-	pF
Output Capacitance	Coss		-	11	-	
Reverse Transfer Capacitance	Crss		-	3.0	-	
Turn-On Delay Time	td <sub>(on)</sub>	$V_{DD}$ =10V, I <sub>D</sub> =600mA, $V_{GS}$ =10V, $R_{G}$ =6 $\Omega$ <sup>(Note 1,2)</sup>	-	2.7	-	-
Turn-On Rise Time	tr		-	21	-	
Turn-Off Delay Time	td <sub>(off)</sub>		-	3.8	-	ns
Turn-Off Fall Time	tf	R <sub>G</sub> =012	-	18	-	
Drain-Source Diode				•	•	•
Maximum Continuous Drain-Source					500	mA
Diode Forward Current	I <sub>S</sub>		-	-	500	
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =500mA, V <sub>GS</sub> =0V	-	0.9	1.5	V

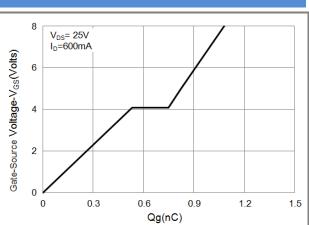
NOTES :

1. Pulse width</br>

- 2. Essentially independent of operating temperature typical characteristics.
- 3. R<sub>®JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. mounted on a 1 inch square pad of copper
- 4. Guaranteed by design, not subject to production testing







**TYPICAL CHARACTERISTIC CURVES** 

### Fig.7 Gate-Charge Characteristics

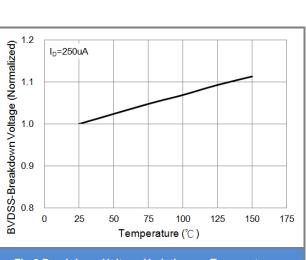
1.5 Vth-G-S Variance 0.0 0.0 1.2 0.3 0 25

Fig.9 Threshold Voltage Variation with Temperature.



V<sub>GS</sub> = 0V f = 1MHz

30





**PJT7872B** 



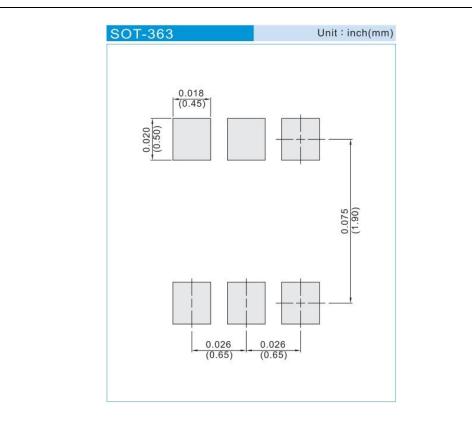




### PART NO PACKING CODE VERSION

PART NO PACKING CODE	Package Type	Packing type	Marking	Version
PJT7872B_R1_00001	SOT-363	3K pcs / 7" reel	T2B	Halogen free
PJT7872B_R2_00001	SOT-363	10K pcs / 13" reel	T2B	Halogen free

### MOUNTING PAD LAYOUT





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